

24A, 30V N-CHANNEL MOSFET

DESCRIPTION

SVG036R8NL5 is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan's LVMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance and high avalanche breakdown tolerance.

This device is widely used in power management for UPS and Inverter Systems.

FEATURES

- 24A, 30V, $R_{DS(on)(typ.)}$ =5.6m Ω @ V_{GS} =10V
- Low gate charge
- Low Crss
- Fast switching
- Extreme dv/dt rated
- 100% avalanche tested
- Pb-free lead plating
- RoHS compliant

S 1 8 D 7 D 6 D 5 D FDFN-8-5X6X0.95-1.27

KEY PERFORMANCE PARAMETERS

Characteristics	Ratings	Unit
V _{DS}	30	V
V _{GS(th)}	1.2~2.2	V
R _{DS(on),max} .	6.8	mΩ
I _D	24	Α
Q _{g.typ.}	15	nC

ORDERING INFORMATION

Part No. Package		Marking	Hazardous Substance Control	Packing Type
SVG036R8NL5TR	PDFN-8-5X6X0.95-1.27	036R8NL5	Halogen free	Tape&Reel

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ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, TJ=25°C)

Characteristics	Symbo	Test conditions		Unit			
Characteristics	1	rest conditions	Min.	Тур.	Max.	Oille	
Drain-source Voltage	V _{DS}		30			V	
Gate-source Voltage	V_{GS}		-20		20	V	
Drain Current (Note 1)		T _C =25°C			24	٨	
Drain Current (Note 1)	I _D	T _C =100°C			24	Α	
Drain Current Pulsed (Note 2)	I _{DM}	T _C =25°C			96	Α	
Power Dissipation (Note 3)	P _D	T _C =25°C			26	W	
Single Pulsed Avalanche	E _{AS}	L=0.5mH, V_{DD} =24V, R_G =25 Ω ,			33.6		
Energy	⊏AS	starting temperature T _J =25°C				mJ	
Single Pulsed Avalanche		ı				11.6	Α
Current	IAS	las	-		11.0	A	
Operation Junction	т.	T _J 55	55	-55	150	°C	
Temperature Range	IJ		-35				
Storage Temperature Range	T _{stg}		-55		150	°C	

THERMAL CHARACTERISTICS

Characteristics	Symbo	Symbo Test conditions		Unit		
	1	rest conditions	Min.	Тур.	Max.	Offic
Thermal Resistance,	$R_{ heta JC}$				4.8	°C/W
Junction-case, Bottom	NθJC					
Thermal Resistance,	В				50	°C/W
Junction-ambient	$R_{\theta JA}$					-0/00
Soldering Temperature(SMD)	T _{sold}	Reflow soldering:10±1sec, 3times			260	°C

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ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED, TJ=25°C)

Static characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
		rest conditions	Min.	Тур.	Max.	Offic
Drain-source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250µA	30			V
Drain-source Leakage Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V, T _J =25°C	1	1	1.0	μΑ
		V _{DS} =30V, V _{GS} =0V, T _J =125°C	1	0.3		μΑ
Gate-source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	1	1	±100	nA
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{GS}=V_{DS}$, $I_{D}=250\mu A$	1.2	1	2.2	٧
Static Drain-source	D	V _{GS} =10V, I _D =20A	-	5.6	6.8	m()
On State Resistance	$R_{DS(on)}$	V _{GS} =4.5V, I _D =20A		8.0	10.5	mΩ
Gate Resistance	R_g	f=1MHz		2.5		Ω

Dynamic characteristics

Characteristics	Sumb of	Symbol Test conditions —	Ratings			l lmit
	Symbol		Min.	Тур.	Max.	Unit
Input Capacitance	C _{iss}			881		
Output Capacitance	Coss	f=1MHz, V _{GS} =0V, V _{DS} =15V		493		pF
Reverse Transfer Capacitance	C _{rss}			48		
Turn-on Delay Time	t _{d(on)}	\/ 00\/ \/ 40\/		4.3		
Turn-on Rise Time	t _r	V _{DD} =20V, V _{GS} =10V,		32		
Turn-off Delay Time	t _{d(off)}	R _G =3.0Ω, I _D =20A		20		ns
Turn-off Fall Time	t _f	(Notes 4, 5)		10		
Total Gate Charge	Qg			15		
Gate-source Charge	Q _{gs}	V _{DD} =15V, V _{GS} =10V, I _D =20A		4.0		nC
Gate-drain Charge	Q_{gd}	(Notes 4, 5)		2.2		
Gate-plateau Voltage	V _{plateau}			3.9		V

Reverse diode characteristics

Characteristics	Symbol Test conditions		Ratings			Unit
Onaracteristics	Symbol	rest conditions	Min.	Тур.	Max.	Oill
Continuous Diode Forward Current	Is	Integral reverse P-N junction	-	-	24	Α
Diode Pulse Current	I _{S,pulse}	diode in the MOSFET		-	96	Α
Diode Forward Voltage	V_{SD}	I _S =1.0A, V _{GS} =0V		-	1.4	V
Reverse Recovery Time	Trr	I _S =20A, V _{GS} =0V, V _R =30V,		25		ns
Reverse Recovery Charge	Q_{rr}	dI _F /dt=100A/μs (Note 4)		9.0		nC

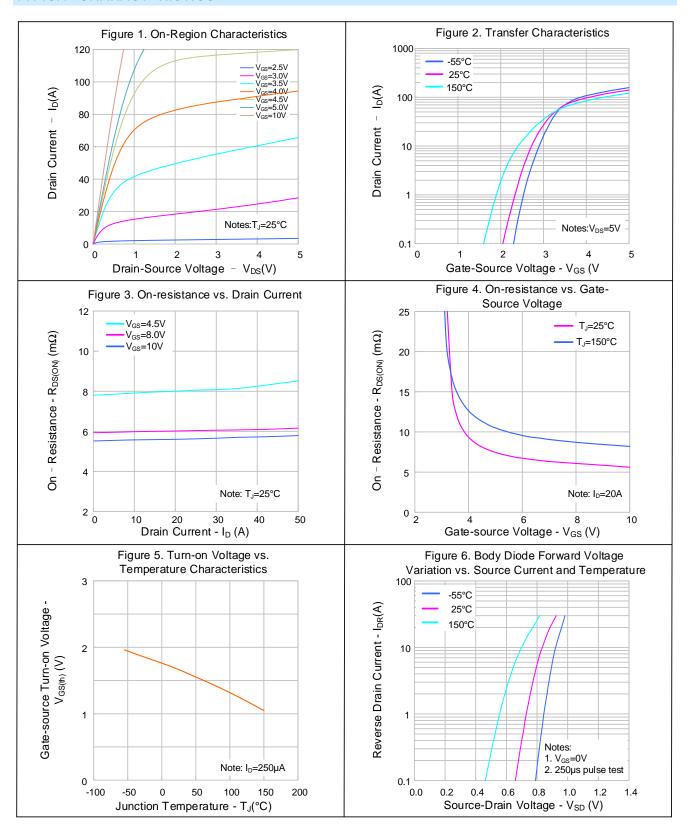
Notes:

- 1. The rated value only refers to the maximum absolute value at the case temperature of 25°C in the specification. If the case temperature is higher than 25°C, it should be derated according to the actual environmental conditions;
- 2. Pulse time 5µs, pulse width is limited by the maximum junction temperature;
- The dissipation power will change with temperature, derating above 25°C: 0.21W/°C; 3.
- 4. Pulse Test: Pulse width ≤300µs, Duty cycle≤2%;
- Essentially independent of operating temperature.

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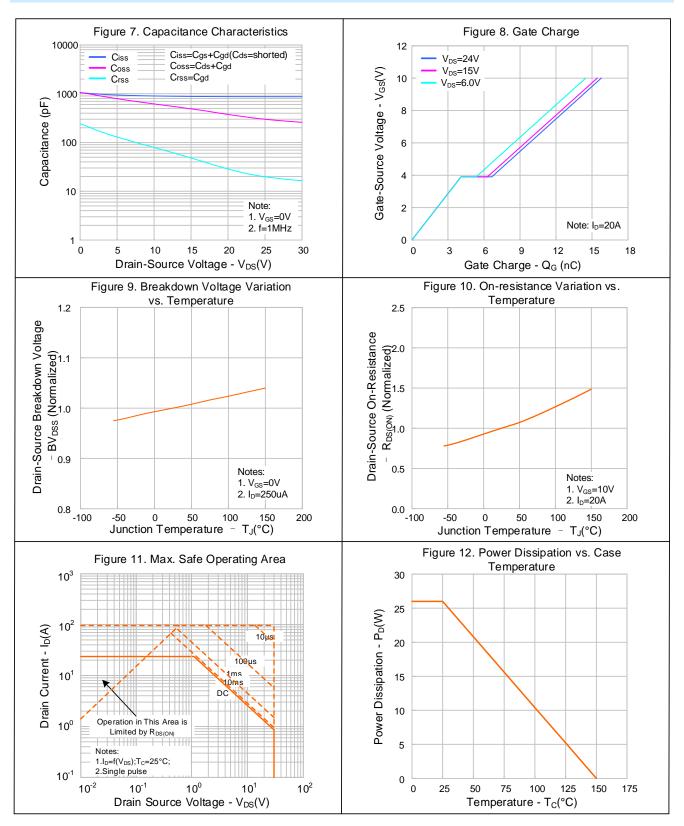
TYPICAL CHARACTERISTICS



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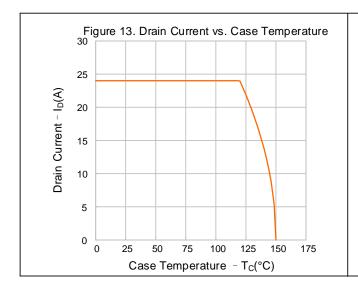
TYPICAL CHARACTERISTICS (CONTINUED)

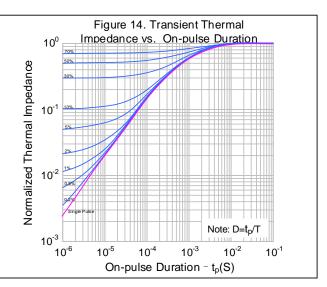


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TYPICAL CHARACTERISTICS (CONTINUED)



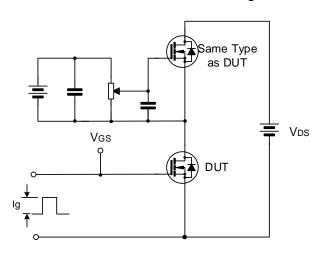


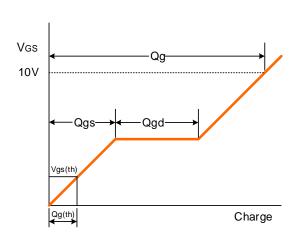
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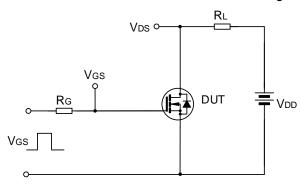
TYPICAL TEST CIRCUIT

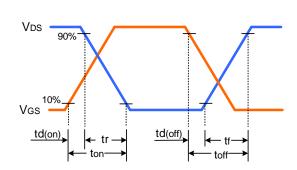
Gate Charge Test Circuit & Waveform



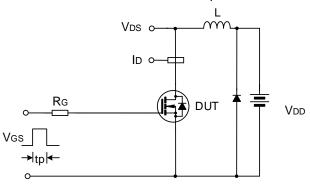


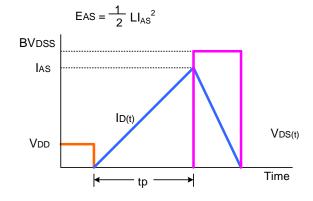
Resistive Switching Test Circuit & Waveform





Unclamped Inductive Switching Test Circuit & Waveform

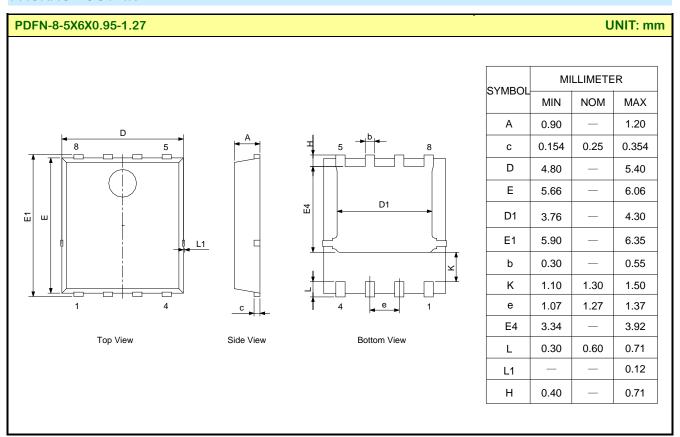




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PACKAGE OUTLINE





MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

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SVG036R8NL5 Datasheet

Important notice:

- 1. Silan reserves the right to make changes of this instruction without notice.
- Customers should obtain the latest relevant information when purchasing and should verify whether such information is latest and complete. Please read this instruction and application manual and related materials carefully before using products, including the circuit operation precautions, etc.
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SVG036R8NL5_Datasheet

SVG036R8NL5 Part No.: Document Type: Datasheet

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Revision History:

Delete the wave soldering condition

2. Update the typical test circuit

Update the important notice 3.

1.0 Rev.:

Revision History:

1. First release

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